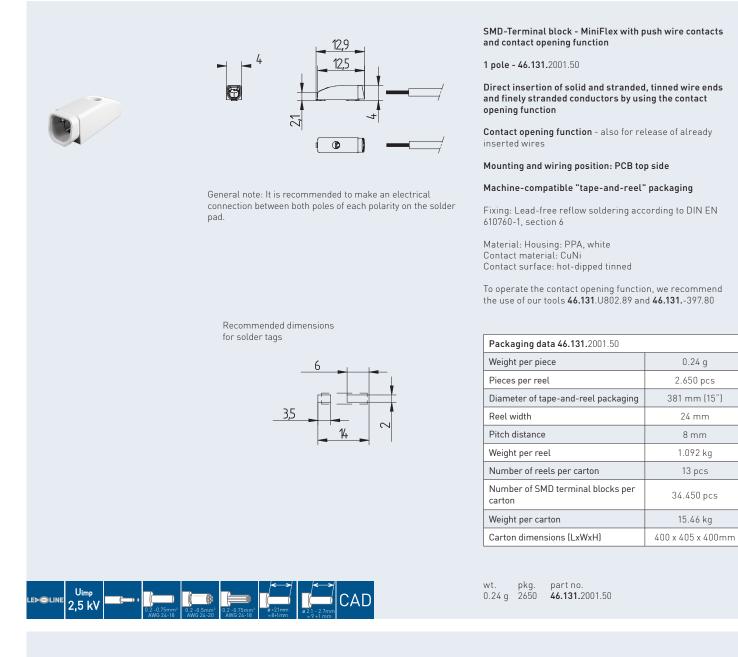
46.131 · SMD Terminal block - MiniFlex

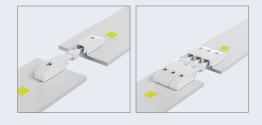




### Accessories:

SMD Mini-Flex-B2B-connector. For connecting PCBs. Connectors are available in 26 mm (U701), 28 mm (U702) and 30 mm (U703) length.





### Contact opening tool

For opening the contacts when using fine-stranded conductors or to remove already inserted conductors.





46.131.U802.89

**46.131.**-397.80

Integrated stripping function for wire ends cut but not stripped

### **SMD Terminal blocks** 46.131 · SMD-Terminal block - MiniFlex General technical information



Connection data	
Connection technology	Push wire contacts
Solid wires	0.20 - 0.75 mm², AWG 24-18
Stranded, tinned wires	0.20 - 0.5 mm², AWG 24-20
Stranded wires	0.20 - 0.75 mm², AWG 24-18
Strip length (ø < 2.1 mm)	8 +1 mm
trip length (ø 2.1 - 2.7 mm)	9 +1 mm
Conductor entry angle to the PCB	0°
Vire release function by	Contact opening tool
Pull-out force according to DN 60999-1	
.2 mm <sup>2</sup>	min. 10 N
).34 mm <sup>2</sup>	min. 15 N
.5 mm <sup>2</sup>	min. 20 N
.75 mm <sup>2</sup>	min. 30 N
nsertion force	max. 10 N
Geometrical data	
Pin spacing	4 mm / 0.16 inch
/idth	4 mm / 0.16 inch
eight	4 mm / 0.16 inch
epth	12.9 mm / 0.51 inch
iameter of tape-and-reel packaging	381 mm (15")
eel width	24 mm
itch distance	8 mm
ackaging unit tape-and-reel	2.700 tbc
ackaging unit cardboard	35.100 (13 reels) tbc
faterial data	
nsulating material group	1
nsulating material	PPA, white
TI	600
lammability class, based on UL 94	VO
Contact material	CuNi
Contact surface	hot-dipped tinned
Mechanical data	
Mounting position	PCB top side
Younting type	Lead-free reflow soldering
「emperature data	
Marginal temperatures	-40 °C to + 150 °C
Ambient temperature	-40 °C to + 105 °C
T-classification according to IEC 60998-1	-

## Rated data according to IEC / EN 60947-7-4 (IEC/EN 60664-1

Rated voltage (III / 3)	63 V	
Rated impulse voltage (III / 3)	2.5 kV	
Rated voltage (III / 2)	160 V	
Rated impulse voltage (III / 2)	2.5 kV	
Rated voltage (II / 2)	320 V	
Rated impulse voltage (II / 2)	2.5 kV	
Rated current	9 A	
Rated data according to UL 1977		
Rated voltage UL 1977	320 V	
Rated current UL 1977	9 A	
Country specific certificates		
VDE ENEC	EN 60947	
UL	cURus, File No. E-365006	
	·	

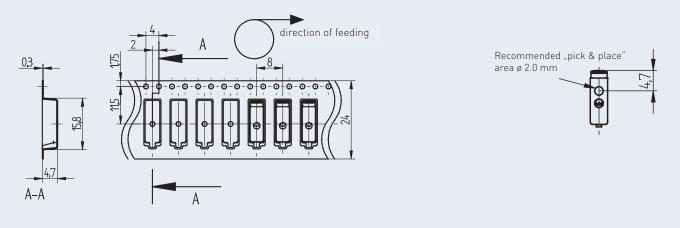
Shear forces according to IEC 62137-1-2: 2007. These values are maximum values that apply only for impuls, not for continuous load.	
Direction 1 + 2 shear force along	50
Direction 3 + 4 shear force across	20
Direction 5 pull-off force	20



#### Instructions for soldering process

Suitable for leadfree-reflow-profiles according to DIN EN 61760-1 respective DIN EN 60068-2-58 up to peak-temperature of max. 260°C. Due to different application-specific parameters (component arrangement and alignment, soldering system, solder paste), it is recommended to use test runs to determine a suitable profile under production conditions.

Depending on the SMD soldering process and associated parameters a minor discoloration might occur. However, this will not influence the functionality.



Storage time	Solderability up to 6 months when stored between -5°C and +40°C and rel. humidity between 1060% r H. After a storage time of 6 months, solderability has to be checked according to J-STD-002D or DIN EN 60068-2-58:2016.	
max. allowed number of reflow-processes	3	
Reflow-profile	Reflow-profile (lead-free) $T_{max} = 260 \text{ °C}$ $t_{max} < 10 \text{ sec}$ $T_{L} \ge 230 \text{ °C}$ $T_{L} \ge 230 \text{ °C}$ $T_{L} : 20 - 60 \text{ sec}$ $T_{L} : 20 - 60 \text{ sec}$	
Solderability	Solderability of components is checked by wetting test according to J-STD-002D	
Assembly method	SMD, according to drawing	
Recommended solder stencil thickness	100 - 150 μm (recommendation BJB 150)	

# **Mouser Electronics**

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

**BJB Electric**:

46.131.2001.50 46.131.2001-004-02